PRODUCT / PROCESS CHANGE NOTIFICATION

1. PCN basic data	
1.1 Company	STMicroelectronics International N.V
1.2 PCN No.	EMBEDDED PROCESSING/26/15379
1.3 Title of PCN	TSMC Foundry (Taiwan) STM32G03/G04x, STM32G05/G06x, STM32G07/G08x and STM32G0B/G0Cx - product enhancement
1.4 Product Category	STM32G030x, STM32G031x, STM32G041x, STM32G050x, STM32G051x, STM32G061x, STM32G070x, STM32G071x, STM32G081x, STM32G0B0x, STM32G0B1x and STM32G0C1x
1.5 Issue date	2026-09-28

2. PCN Team	
2.1 Contact supplier	
2.1.1 Name	SCHAEFER MARC
2.1.2 Phone	+49 89460062136
2.1.3 Email	marc.schaefer@st.com
2.2 Change responsibility	
2.2.1 Product Manager	Patrick AIDOUNE
2.1.2 Marketing Manager	Marie TOURNUT
2.1.3 Quality Manager	Pascal NARCHE

3. Change		
3.1 Category	3.2 Type of change	3.3 Manufacturing Location
General Product & Design	Die redesign : Mask or mask set change with new die design like metallization (specifically chip frontside) or bug fix	TSMC foundry (Taiwan)

4. Description of change		
	Old	New
4.1 Description	Current TSMC (Taiwan) product revisions: - STM32G03x, STM32G04x (Cut1.2) Die revision “Y” - STM32G05x, STM32G06x (Cut1.1) Die revision “Z” - STM32G07x, STM32G08x (Cut2.1) Die revision “Y” - STM32G0Bx, STM32G0Cx (Cut1.1) Die revision “Z”	TSMC (Taiwan) product revision with Fixes as described in Errata Sheets New product revisions: - STM32G03x, STM32G04x (Cut1.3) Die revision “5” - STM32G05x, STM32G06x (Cut1.2) Die revision “Y” - STM32G07x, STM32G08x (Cut2.2) Die revision “X” - STM32G0Bx, STM32G0Cx (Cut1.2) Die revision “Y” Errata Sheet reference list STM32G030x ES0486 STM32G031x ES0487 STM32G041x ES0488 STM32G050x ES0544 STM32G051x ES0545 STM32G061x ES0546 STM32G070x ES0468 STM32G071x ES0418 STM32G081x ES0412 STM32G0B0x ES0547 STM32G0B1x ES0548 STM32G0C1x ES0549
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	Yield improvement	

5. Reason / motivation for change	
5.1 Motivation	Improvements was implemented to increase robustness, performances and quality of our products.
5.2 Customer Benefit	SERVICE CONTINUITY

6. Marking of parts / traceability of change	
6.1 Description	Traceability ensured by ST internal tools. Die revision changes on Package Marking. Please refer to PCN15379 additional information document

7. Timing / schedule	
7.1 Date of qualification results	2026-10-15
7.2 Intended start of delivery	2026-10-30
7.3 Qualification sample available?	Upon Request

8. Qualification / Validation			
8.1 Description	15379 PCN15379_G0 PMU fix_Die 456_460_466 _467_REL Plan.pdf		
8.2 Qualification report and qualification results	Available (see attachment)	**Issue Date**	2026-09-28

9. Attachments (additional documentations)
15379 Public product.pdf 15379 PCN15379_G0 PMU fix_Die 456_460_466 _467_REL Plan.pdf 15379 _Additional information.pdf

10. Affected parts		
10. 1 Current		**10.2 New (if applicable)**
10.1.1 Customer Part No	**10.1.2 Supplier Part No**	**10.1.2 Supplier Part No**
	STM32G030F6P6TR	
	STM32G030K8T6TR	
	STM32G031G8U6TR	
	STM32G031K8U6TR	
	STM32G071CBT6TR	
	STM32G071GBU6	
	STM32G071KBU6TR	
	STM32G0B1RCI6NTR	
	STM32G0B1RET7	
	STM32GP0B1RAEXTR	

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PRODUCT/PROCESS CHANGE NOTIFICATION PCN15379 – Additional information

TSMC Foundry (Taiwan) STM32G03/G04x, STM32G05/G06x, STM32G07/G08x and STM32G0B/G0Cx - product enhancement

MDRF – General Purpose and Automotive Microcontrollers Division (GPAM)

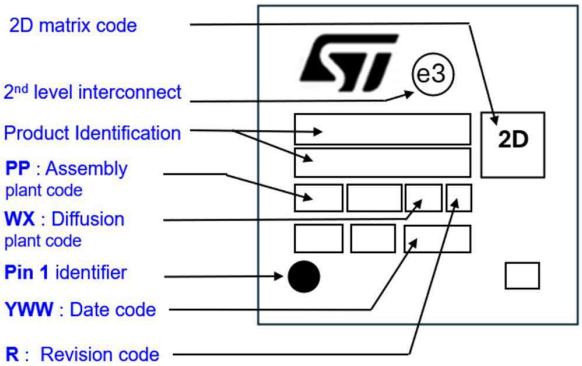
What are the changes?

Changes described in table below:

	TSMC (Taiwan)	
	Current condition	New condition
STM32G03x, STM32G04x	Cut1.2	Cut1.3
Marking **R**	"**Y**"	"**5**"
STM32G05x, STM32G06x	Cut1.1	Cut1.2
Marking **R**	"**Z**"	"**Y**"
STM32G07x, STM32G08x	Cut2.1	Cut2.2
Marking **R**	"**Y**"	"**X**"
STM32G0Bx, STM32G0Cx	Cut1.1	Cut1.2
Marking **R**	"**Z**"	"**Y**"

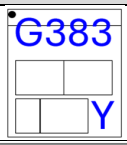
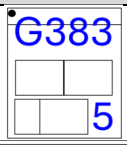
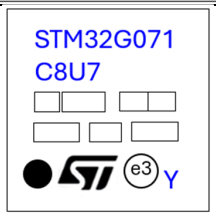
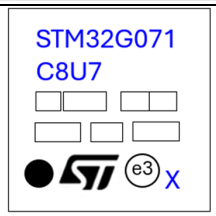
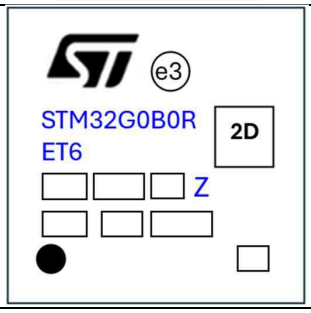
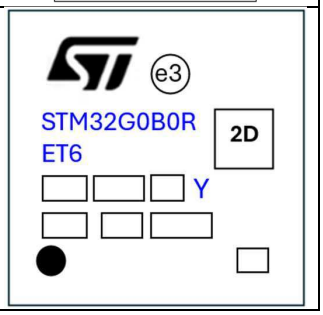
How can the change be seen?

Standard top view marking for LQFP 64 10x10 as below



Please refer to Technical Note **TN1433** for package marking details.

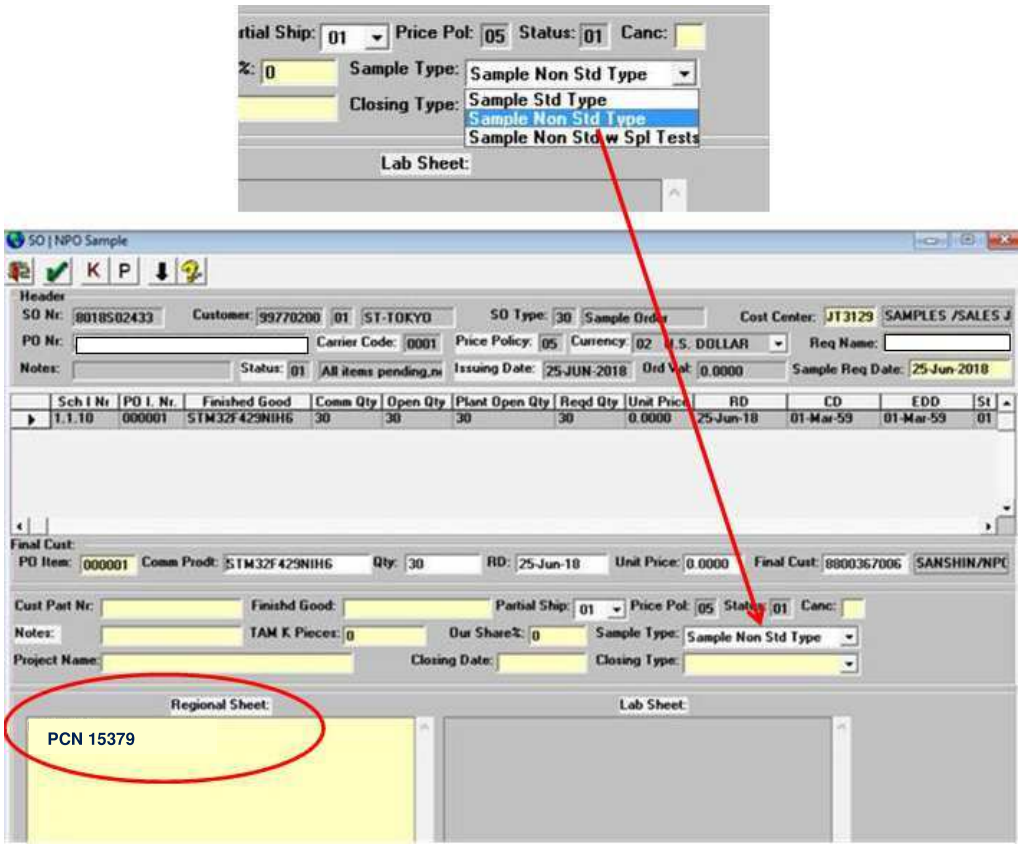
Marking Example with Commercial product:

	TSMC (Taiwan)	
	Current condition	New condition
WLCSP 18L (ie: STM32G031Y8Y3TR)		
TSSOP 20 (ie: STM32G061F8P6)		
UFQFPN 7X7 48L (ie : STM32G071C8U7)		
LQFP 10x10 64L (ie: STM32G0B0RET6)		

How to order samples?

For all samples request linked to this PCN, please:

- place a **Non-standard** sample order (choose Sample Non Std Type from pull down menu)
- insert the PCN number "**PCN15379**" into the NPO Electronic Sheet/**Regional Sheet**
- request sample(s) through Notice tool, indicating a single Commercial Product for each request



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PCN 15379 TSMC Foundry (Taiwan) STM32G03/G04x, STM32G05/G06x, STM32G07/G08x and STM32G0B/G0Cx - product enhancement Reliability Plan

August 24th, 2026

GPM Quality & Reliability Department

STM32G030x/G031x/G041x (die 466 cut1.3) die reliability trials RER1808 V3.0

Reliability Trial & Standard&		Test Conditions	Pass Criteria	Lot Strategy (diffusion)	Units per lot
ESD HBM	ANSI/ESDA JEDEC JS-001	1500 Ohms, 100pF 2kV (Class 2)	A0R1	1 lot (*)	3
LU	JESD78	130°C	A0R1	1 Lot (*)	3
HTOL	JESD22-A108	125°C 3.6V / 168h	A0R1	1 lot (*)	77

(*) Reliability trials are performed using parts from one diffusion plant (ST Crolles). Other diffusion plants (ST Agrate 300 and TSMC FAB14) are qualified by similarity.

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STM32G05x/G06x (die 456 cut1.2) die reliability trials RER2012 V2.0

Reliability Trial & Standard&		Test Conditions	Pass Criteria	Lot Strategy (diffusion)	Units per lot
ESD HBM	ANSI/ESDA JEDEC JS-001	1500 Ohms, 100pF 2kV (Class 2)	A0R1	1 lot (*)	3
LU	JESD78	130°C	A0R1	1 Lot (*)	3
HTOL	JESD22-A108	125°C 3.6V / 168h	A0R1	1 lot (*)	77

(*) Reliability trials are performed using parts from one diffusion plant (ST Crolles). Other diffusion plant (TSMC FAB14) is qualified by similarity.

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STM32G070x/071x/081x (die 460 cut2.2) die reliability trials RER1602 V7.0

Reliability Trial & Standard&		Test Conditions	Pass Criteria	Lot Strategy (diffusion)	Units per lot
ESD HBM	ANSI/ESDA JEDEC JS-001	1500 Ohms, 100pF 2kV (Class 2)	A0R1	1 lot (*)	3
LU	JESD78	130°C	A0R1	1 Lot (*)	3
HTOL	JESD22-A108	125°C 3.6V / 168h	A0R1	1 lot (*)	77

(*) Reliability trials are performed using parts from one diffusion plant (ST Crolles). Other diffusion plant (TSMC FAB14) is qualified by similarity.

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STM32G0Bx (die 467 cut1.2) die reliability trials RER1918 V2.0

Reliability Trial & Standard&		Test Conditions	Pass Criteria	Lot Strategy (diffusion)	Units per lot
ESD HBM	ANSI/ESDA JEDEC JS-001	1500 Ohms, 100pF 2kV (Class 2)	A0R1	1 lot (*)	3
LU	JESD78	130°C	A0R1	1 Lot (*)	3
HTOL	JESD22-A108	125°C 3.6V / 168h	A0R1	1 lot (*)	77

(*) Reliability trials are performed using parts from one diffusion plant (TSMC FAB14). Other diffusion plant (ST Crolles 300) is qualified by similarity.

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Public Products List

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PCN Title : TSMC Foundry (Taiwan) STM32G03/G04x, STM32G05/G06x, STM32G07/G08x and STM32G0B/G0Cx - product enhancement

PCN Reference : EMBEDDED PROCESSING/26/15379

Subject : Public Products List

Dear Customer,

Please find below the Standard Public Products List impacted by the change.

STM32G0B0CET6TR	STM32G0B1KEU6N	STM32G071R8T6
STM32G031K8T3	STM32G071CBT6	STM32G031G4U6
STM32G031K8U6TR	STM32G030K6T6	STM32G071KBT3
STM32G031C8T6TR	STM32G0C1VCT6	STM32G031G6U6
STM32G0C1CEU3	STM32G031C6T7	STM32G071KBT6TR
STM32G031C8U3	STM32G041K6T6	STM32G070CBT6TR
STM32G0B1VCT6TR	STM32G0C1RET3	STM32G041K6U3
STM32G031J6M6	STM32G0B1CCU7TR	STM32G030C8T6TR
STM32G071GBU7	STM32G0B1CBU6	STM32G0B1RCT6N
STM32G031C8T7	STM32G0B1CBU6N	STM32G0C1RCT3
STM32G0B1KEU6	STM32G0B1CCU3TR	STM32G071RBT7TR
STM32G0B1CCU6	STM32G041K8U6	STM32G031F8P3
STM32G050K8T6	STM32G0B1CCU6TR	STM32G030C6T6TR
STM32G0B1RBT6	STM32G071CBT6TR	STM32G071C8U7
STM32G071CBT7	STM32G031G6U7	STM32G071KBU7
STM32G031C6T6	STM32G071CBU3TR	STM32G0B1RBT3TR
STM32G061K6U6	STM32G031G8U6TR	STM32G071KBU6N
STM32G0C1RCT6TR	STM32G031F8P3TR	STM32G041F6P6
STM32G071CBT7TR	STM32G031K8U7TR	STM32G070CBT6
STM32G071RBT6TR	STM32G0B1CBU3	STM32G0B1CBU7
STM32G070RBT6	STM32G031G8U3TR	STM32G0B1KET6
STM32G0B1KBU6TR	STM32G071KBU6	STM32G071C8U3
STM32G071G8U6N	STM32G070RBT6TR	STM32G0B1CEU6N
STM32G0B1CBT6	STM32G071G8U6TR	STM32G051F8P3
STM32G0B1CCT6	STM32G071C8T7TR	STM32G031J6M3
STM32G071KBT3TR	STM32G071C8U7TR	STM32G0B1RCT3
STM32G0B1CEU6TR	STM32G061K6T6	STM32G0C1RET6
STM32G030K8T6TR	STM32G031C8U6	STM32G031J4M3TR
STM32G0C1CEU6	STM32G071KBU3	STM32G031G8U6
STM32G0B1RCT7	STM32G071KBT6	STM32G0B1RCT6TR
STM32G0B1MBT6	STM32G0B0CET6	STM32G0B1CCU3
STM32G071C8T6	STM32G041K6U3TR	STM32G031G6U3TR
STM32G031F6P7	STM32G030C6T6	STM32G031F8P6TR
STM32G0B1KEU3N	STM32G041F8P6	STM32G031K4T3
STM32G071R8T7	STM32G0C1RCT6	STM32G0B1VET7

STM32G071C8T3	STM32G051C8T3TR	STM32G031C8U3TR
STM32G031K4U6TR	STM32G030K6T6TR	STM32G030F6P6
STM32G031K6T6TR	STM32G031F6P6TR	STM32G031C8U7TR
STM32G051C8U6	STM32G0B0KET6	STM32G031F8P7
STM32G031C8T6	STM32G031Y8Y3TR	STM32G0C1CET6
STM32G0B1KBU7TR	STM32G031C6T7TR	STM32G030C8T6
STM32G031K4U3TR	STM32G061C8T6	STM32G071G8U6NTR
STM32G0B1RET7	STM32G031K6U7	STM32G0C1RCI6NTR
STM32G0B1RCT6	STM32G051K6U7	STM32G0B1CEU7
STM32G071KBU6TR	STM32G031K8T7	STM32G031C8T3
STM32G041C8U6	STM32G041G8U6	STM32G031K8T6
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STM32G051K8T6TR	STM32G081RBT6	STM32G071R8T3
STM32G061C8U6	STM32G071CBU3	STM32G031J6M6TR
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STM32G081CBU6	STM32G0B1CET6	STM32G031K8U3
STM32G031G8U7	STM32G0B1CCT6TR	STM32G0C1KCT6N
STM32G031K8T3TR	STM32G031F8P6	STM32G071R8T7TR
STM32G0B1VBT6	STM32G0B1VEI7	STM32G0B1VCT6
STM32G061C6U6	STM32G031F4P3	STM32G0B1RET3
STM32G071CBU7	STM32G0B1CBU3TR	STM32G051G8U6
STM32G041G6U6	STM32G031C8T3TR	STM32G071C8T6TR
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STM32G0C1CEU3TR	STM32G071RBT6	STM32G0B1KCU3TR
STM32G0C1CEU6TR	STM32G081CBU3TR	STM32G031F6P7TR
STM32G031K8T6TR	STM32G0B1KCU7TR	STM32G0B1VBI6
STM32G0B1KEU6TR	STM32G081RBT6TR	STM32G0B1KCU6
STM32G0B1VCT7	STM32G0C1CCU6TR	STM32G081GBU6
STM32G031F4P6	STM32G031K8U3TR	STM32G0B1RCT7TR
STM32G0B1KBU6	STM32G081EBY6TR	STM32G0B1CCT7TR
STM32G031K8T7TR	STM32G051F8Y3TR	STM32G0B1CBU6TR
STM32G051K8U6	STM32G061F6P6	STM32G0C1RCI6N

STM32G0B1RCI6NTR	STM32G081CBT6	STM32G0B1CEU6
STM32G071C8U3TR	STM32G0B1VEI6	STM32G081EBY3TR
STM32G0B1CET6TR	STM32G031G6U6TR	STM32G0C1VET6
STM32G0B1KCU3	STM32G0B1KBT6TR	STM32G031F4P6TR
STM32G0B1KCT6N	STM32G071GBU6TR	STM32G0B1CEU7TR
STM32G071C8U6TR	STM32G0B1CCU7	STM32G071K8U6
STM32G071GBU3	STM32G070KBT6	STM32G0B1KET3TR
STM32G0B1VBT7TR	STM32G071EBY6TR	STM32G051K6T6
STM32G0B1KEU7TR	STM32G0B1RBT7TR	STM32G071CBU7TR
STM32G071KBT6N	STM32G051F6P6	STM32G0B1RET6
STM32G0C1KCU6	STM32G0B1RCI6N	STM32G071C8T3TR
STM32G0B0RET6	STM32G0B1CCT7	STM32G051C6U6
STM32G071GBU3TR	STM32G031C8U7	STM32G051C8T6
STM32G071RBT3	STM32G0B1VBT7	STM32G071KBU7TR
STM32G041F6P6TR	STM32G0B1VCI6	STM32G071RBT7
STM32G0B1CCU6N	STM32G051G8U3	STM32G071GBU6
STM32G0B1CBT3	STM32G0C1KCU3	STM32G071EBY3TR
STM32G030F6P6TR	STM32G0B1VET6TR	STM32G061G8U6
STM32G0B1RBT6TR	STM32G031J4M3	STM32G071CBT3TR
STM32G081CBT3TR	STM32G0B1VET7TR	STM32G031C4U6
STM32G071GBU7TR	STM32G0C1KEU6TR	STM32G051K8U7TR
STM32G081RBT3	STM32G051K6U7TR	STM32G051C6U7
STM32G051F8P6	STM32G081CBT3	STM32G081CBT6TR
STM32G071K8T3TR	STM32G071GBU6N	STM32G051C8T3
STM32G030J6M6	STM32G030J6M6TR	STM32G050F6P6
STM32G0B1CBT6TR	STM32G051C8U6TR	STM32G0B1KBU7
STM32G0B1KCU7	STM32G0B1KBU3N	STM32G061K8T6
STM32G061F8P6	STM32G0B1RBI6N	STM32G0C1MET6
STM32G0B1RBI3N	STM32G041J6M6	STM32G0C1MCT6
STM32G0B1RET3TR	STM32G031C6U6	STM32G061F8Y6TR
STM32G0C1KET6	STM32G0B1KBU6N	STM32G050C8T6
STM32G0C1REI6N	STM32G051K6U6	STM32G0B1KET6N
STM32G0C1KCU6N	STM32G051G8U6TR	STM32G061G6U6
STM32G051F8P6TR	STM32G051F8P3TR	STM32G0B1CBT3TR
STM32G0B1VCI6TR	STM32G071RBI3TR	STM32G0B1REI6N
STM32G0B1VEI7TR	STM32G0B1RBI3NTR	STM32G0B1KCU6N
STM32G051G6U3TR	STM32G061C6T6	STM32G051K8T7TR
STM32G0B1RET6N	STM32G061C8T6TR	STM32G031J4M6
STM32G0B1MCT6	STM32G0C1REI6NTR	STM32G0B1RCT6NTR
STM32G0B1KBT6	STM32G0B1KBT6N	STM32G0B1KCT6TR
STM32G071RBI6	STM32G0B1REI6NTR	STM32G051C8U3TR
STM32G0B1KBT3	STM32G0C1KET6N	STM32G031F6P3TR
STM32G081RBI6	STM32G050K6T6TR	STM32G0B1RBT3
STM32G061G8U6TR	STM32G051G8U3TR	STM32G0B1NEY6TR
STM32G0B1REI7N	STM32G071RBI3	STM32G0B1MET6
STM32G050K6T6	STM32G051G6U6	STM32G0B1KBT6NTR
STM32G050C8T6TR	STM32G050C6T6	STM32G051G6U3
STM32G031F6P3	STM32G0B1CET6N	STM32G051K8T6
STM32G0C1RET3TR	STM32G051C8U7TR	STM32G0B1KCT6
STM32G0B1KET6TR	STM32G0C1VET3	STM32G050K8T6TR

STM32G051K8T7	STM32G041Y8Y6TR	STM32G051C6T6

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